

20 V, complementary N/P-channel Trench MOSFET 30 June 2015 Product

Product data sheet

### 1. General description

Complementary N/P-channel enhancement mode Field-Effect Transistor (FET) in a leadless ultra small DFN1010B-6 (SOT1216) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 2. Features and benefits

- Trench MOSFET technology
- Very low threshold voltage for portable applications:  $V_{GS(th)} = 0.7 V$
- Leadless ultra small and ultra thin SMD plastic package: 1.1 × 1.0 × 0.37 mm
- ElectroStatic Discharge (ESD) protection > 1 kV HBM

### 3. Applications

- Relay driver
- High-speed line driver
- Level shifter
- Power management in battery-driven portables

### 4. Quick reference data

Table 1. Qu	ick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-chani	nel), Static characteristic	S					
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 600 mA; T <sub>j</sub> = 25 °C		-	470	620	mΩ
TR2 (P-chann	nel), Static characteristic	S		÷			
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -500 mA; T <sub>j</sub> = 25 °C		-	1.02	1.4	Ω
TR1 (N-chani	nel)	·					,
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 4.5 V; T <sub>amb</sub> = 25 °C	[1]	-	-	600	mA
TR2 (P-chani	nel)	·					,
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C	[1]	-	-	-500	mA

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- Table 2. **Pinning information** Pin Symbol Description **Simplified outline Graphic symbol** 1 S1 source TR1 D1 D2 1 6 2 G1 gate TR1 7  $\Lambda$ drain TR2 3 D2 G1 2 5 G2 V 4 S2 source TR2 8 R 3 4 gate TR2 5 G2 S1 S2 6 D1 drain TR1 017aaa262 Transparent top view D1 drain TR1 7 DFN1010B-6 (SOT1216) 8 D2 drain TR2
- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm<sup>2</sup>.

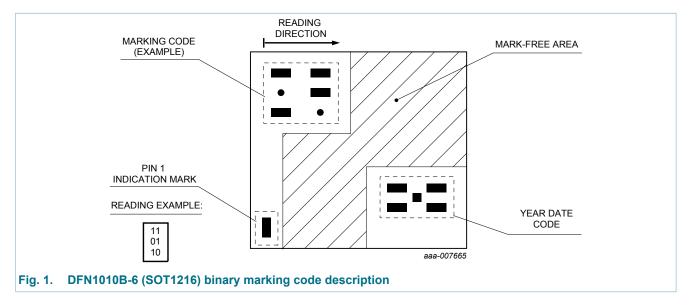
### 5. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
PMCXB900UE	DFN1010B-6	DFN1010B-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals	SOT1216				

### 6. Marking

#### Table 4. Marking codes

Type number	Marking code
PMCXB900UE	10 00 00



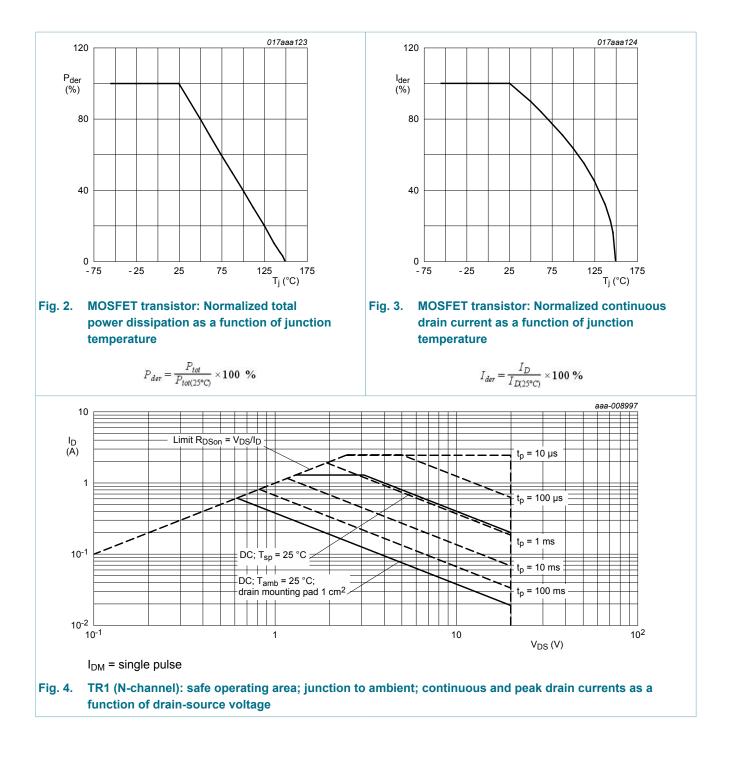
#### **Limiting values** 7.

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

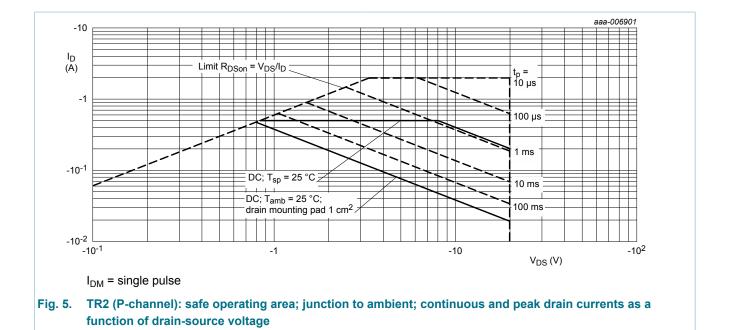
Symbol	Parameter	Conditions		Min	Max	Unit
TR1 (N-cha	nnel)					_
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	20	V
V <sub>GS</sub>	gate-source voltage			-8	8	V
I <sub>D</sub>	drain current	$V_{GS}$ = 4.5 V; $T_{amb}$ = 25 °C	[1]	-	600	mA
		V <sub>GS</sub> = 4.5 V; T <sub>amb</sub> = 100 °C	[1]	-	400	mA
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	2.5	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	265	mW
			[1]	-	380	mW
		T <sub>sp</sub> = 25 °C		-	4025	mW
TR1 (N-cha	nnel), Source-drain diode					
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	400	mA
TR2 (P-cha	nnel)			·		
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-20	V
V <sub>GS</sub>	gate-source voltage			-8	8	V
I <sub>D</sub>	drain current	$V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C	[1]	-	-500	mA
		$V_{GS}$ = -4.5 V; $T_{amb}$ = 100 °C	[1]	-	-300	mA
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-2	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	265	mW
			[1]	-	380	mW
		T <sub>sp</sub> = 25 °C		-	4025	mW
TR2 (P-cha	nnel), Source-drain diode					
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-350	mA
Per device					1	
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

 Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm<sup>2</sup>.
Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



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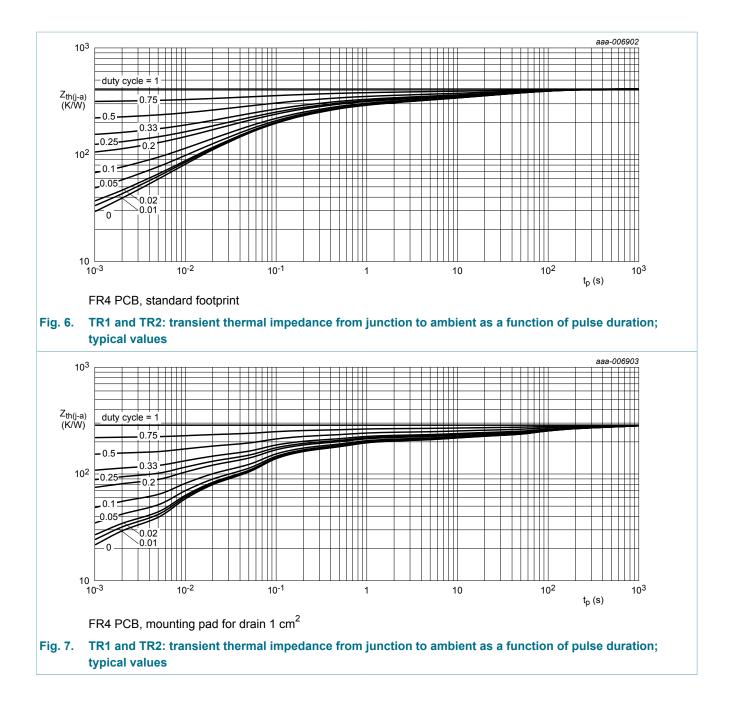
# 8. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-cha	innel)						,
R <sub>th(j-a)</sub>	thermal resistance	in free air	[1]	-	410	475	K/W
	from junction to ambient		[2]	-	285	330	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	27	31	K/W
TR2 (P-cha	nnel)	1					
R <sub>th(j-a)</sub>	thermal resistance	in free air	[1]	-	410	475	K/W
	from junction to ambient		[2]	-	285	330	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	27	31	K/W

[1] Device mounted on an FR4 PCB, single-sided copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm<sup>2</sup>.





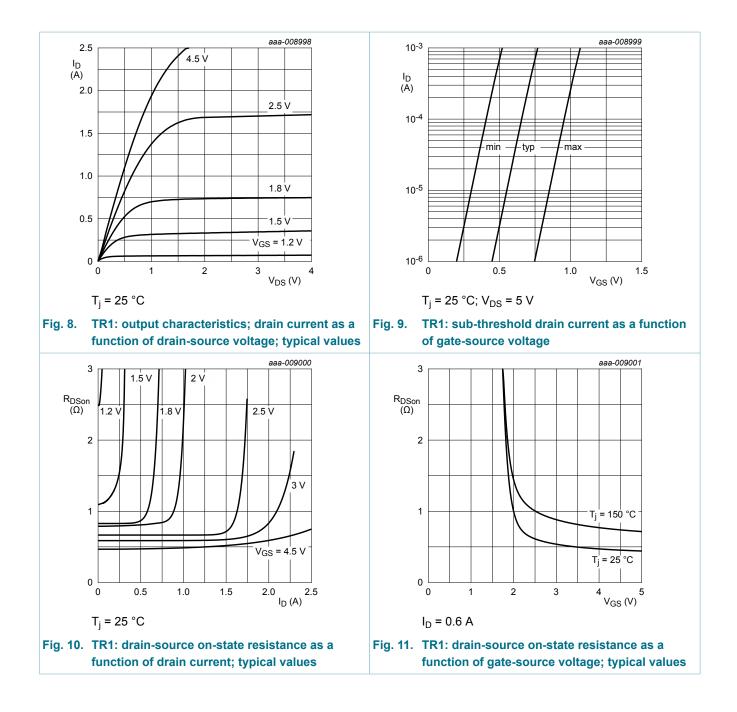
### 9. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (N-cha	nnel), Static characteristic	is in the second s				
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	20	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = 250 µA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	0.45	0.7	0.95	V
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = 20 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	1	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 8 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	10	μA
		V <sub>GS</sub> = -8 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-10	μA
		$V_{GS}$ = 4.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	1	μA
		$V_{GS}$ = -4.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	-1	μA
R <sub>DSon</sub>	drain-source on-state	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 600 mA; T <sub>j</sub> = 25 °C	-	470	620	mΩ
	resistance	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 600 mA; T <sub>j</sub> = 150 °C	-	760	1000	mΩ
		$V_{GS}$ = 2.5 V; I <sub>D</sub> = 500 mA; T <sub>j</sub> = 25 °C	-	620	850	mΩ
		V <sub>GS</sub> = 1.8 V; I <sub>D</sub> = 100 mA; T <sub>j</sub> = 25 °C	-	845	1300	mΩ
		V <sub>GS</sub> = 1.5 V; I <sub>D</sub> = 10 mA; T <sub>j</sub> = 25 °C	-	1125	3000	mΩ
		$V_{GS}$ = 1.2 V; I <sub>D</sub> = 1 mA; T <sub>j</sub> = 25 °C	-	2210	-	mΩ
9 <sub>fs</sub>	transfer conductance	$V_{DS}$ = 5 V; I <sub>D</sub> = 600 mA; T <sub>j</sub> = 25 °C	-	1	-	S
TR1 (N-cha	nnel), Dynamic characteri	stics				
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = 10 V; I <sub>D</sub> = 600 mA; V <sub>GS</sub> = 4.5 V;	-	0.4	0.7	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	0.1	-	nC
Q <sub>GD</sub>	gate-drain charge		-	0.1	-	nC
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 10 V; f = 1 MHz; V <sub>GS</sub> = 0 V;	-	21.3	-	pF
C <sub>oss</sub>	output capacitance	$T_j = 25 °C$	-	5.4	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	4.2	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 10 V; I <sub>D</sub> = 600 mA; V <sub>GS</sub> = 4.5 V;	-	5.6	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	9.2	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	19	-	ns
t <sub>f</sub>	fall time		-	51	-	ns
TR1 (N-cha	nnel), Source-drain diode	characteristics	1	1		
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 360 mA; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	0.8	1.2	V

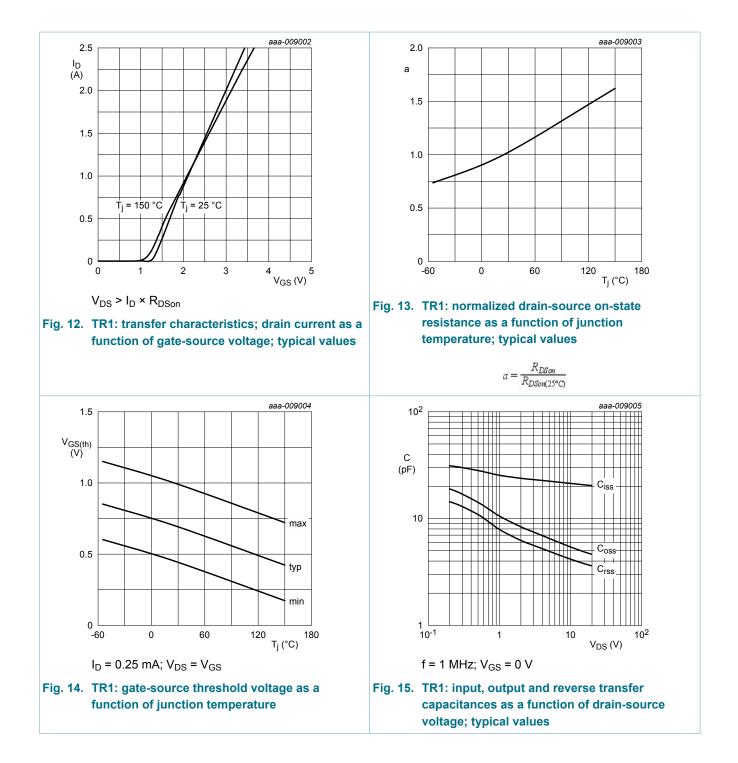
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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
TR2 (P-cha	nnel), Static characteristic	S				
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D$ = -250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-20	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-0.45	-0.7	-0.95	V
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = -20 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	-1	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 8 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		$V_{GS}$ = -8 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	-10	μA
		$V_{GS}$ = 4.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	1	μA
		$V_{GS}$ = -4.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	-1	μA
R <sub>DSon</sub>	drain-source on-state	$V_{GS}$ = -4.5 V; I <sub>D</sub> = -500 mA; T <sub>j</sub> = 25 °C	-	1.02	1.4	Ω
	resistance	$V_{GS}$ = -4.5 V; I <sub>D</sub> = -500 mA; T <sub>j</sub> = 150 °C	-	1.54	2.1	Ω
		$V_{GS}$ = -2.5 V; I <sub>D</sub> = -200 mA; T <sub>j</sub> = 25 °C	-	1.27	2.2	Ω
		$V_{GS}$ = -1.8 V; I <sub>D</sub> = -40 mA; T <sub>j</sub> = 25 °C	-	1.7	3.3	Ω
		$V_{GS}$ = -1.5 V; I <sub>D</sub> = -10 mA; T <sub>j</sub> = 25 °C	-	2.3	5	Ω
		V <sub>GS</sub> = -1.2 V; I <sub>D</sub> = -1 mA; T <sub>j</sub> = 25 °C	-	3.5	-	Ω
9 <sub>fs</sub>	transfer conductance	$V_{DS}$ = -10 V; I <sub>D</sub> = -500 mA; T <sub>j</sub> = 25 °C	-	480	-	mS
TR2 (P-cha	nnel), Dynamic characteris	stics	I			
Q <sub>G(tot)</sub>	total gate charge	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -450 mA;	-	1.19	2.1	nC
Q <sub>GS</sub>	gate-source charge	V <sub>GS</sub> = -4.5 V; T <sub>j</sub> = 25 °C	-	0.17	-	nC
Q <sub>GD</sub>	gate-drain charge		-	0.1	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS}$ = -10 V; f = 1 MHz; $V_{GS}$ = 0 V;	-	43	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	14	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	8	-	pF
t <sub>d(on)</sub>	turn-on delay time	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -450 mA;	-	2.3	-	ns
t <sub>r</sub>	rise time	V <sub>GS</sub> = -4.5 V; R <sub>G(ext)</sub> = 6 Ω; T <sub>j</sub> = 25 °C	-	5	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	13.5	-	ns
t <sub>f</sub>	fall time		-	6	-	ns
TR2 (P-cha	nnel), Source-drain diode	characteristics		_		
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = -115 mA; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	-0.7	-1.2	V

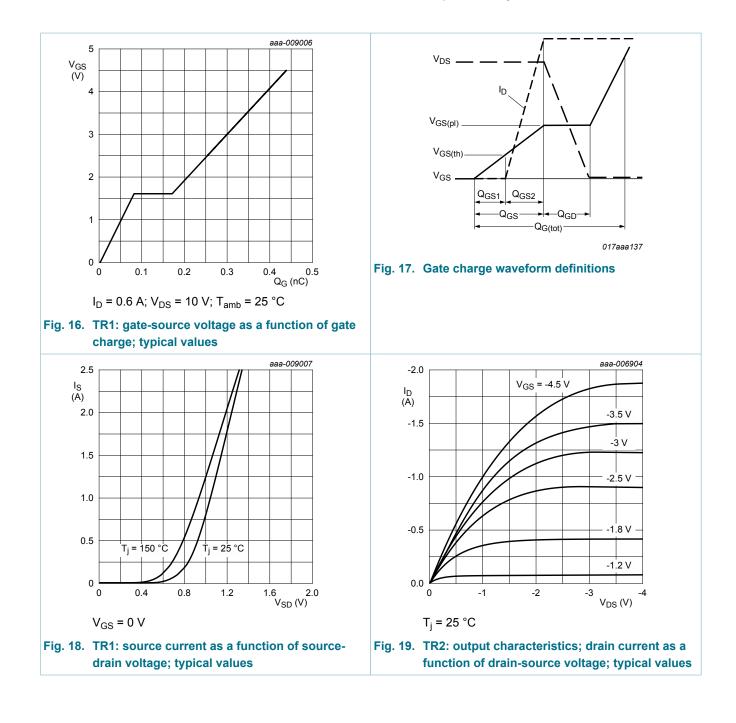
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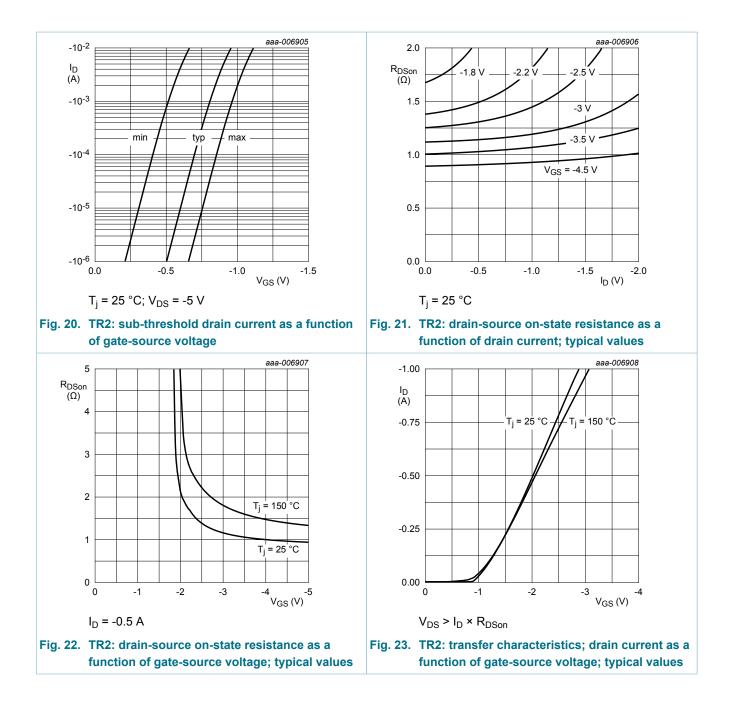
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### PMCXB900UE

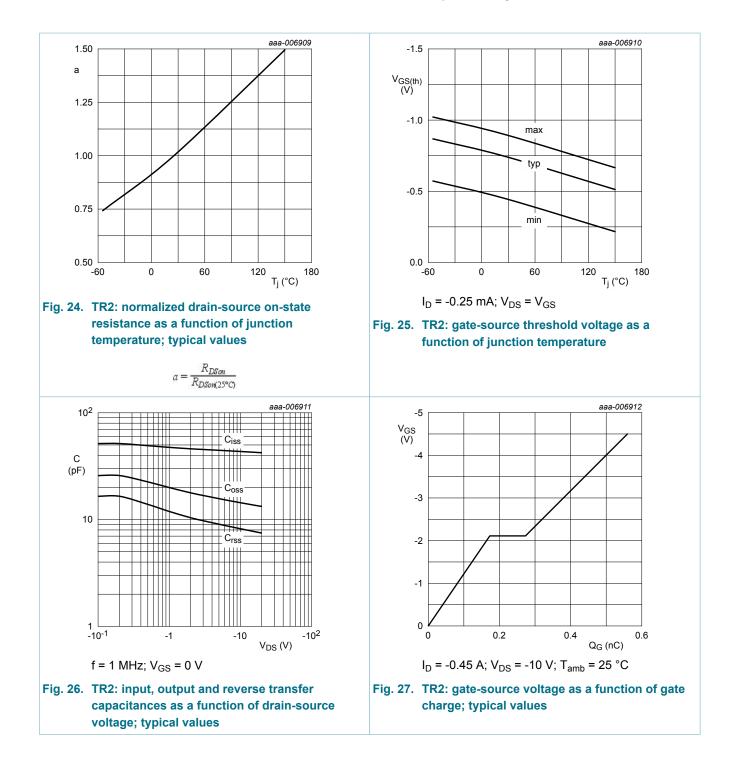


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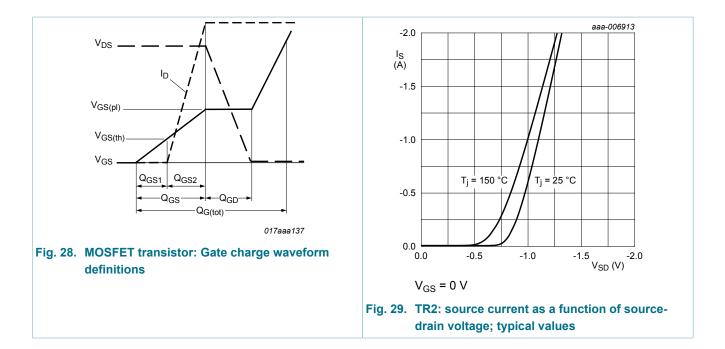
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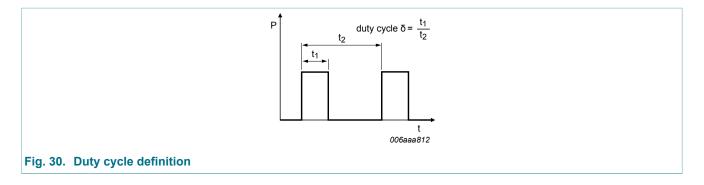


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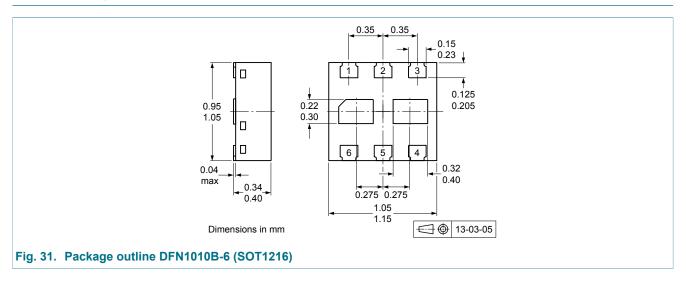
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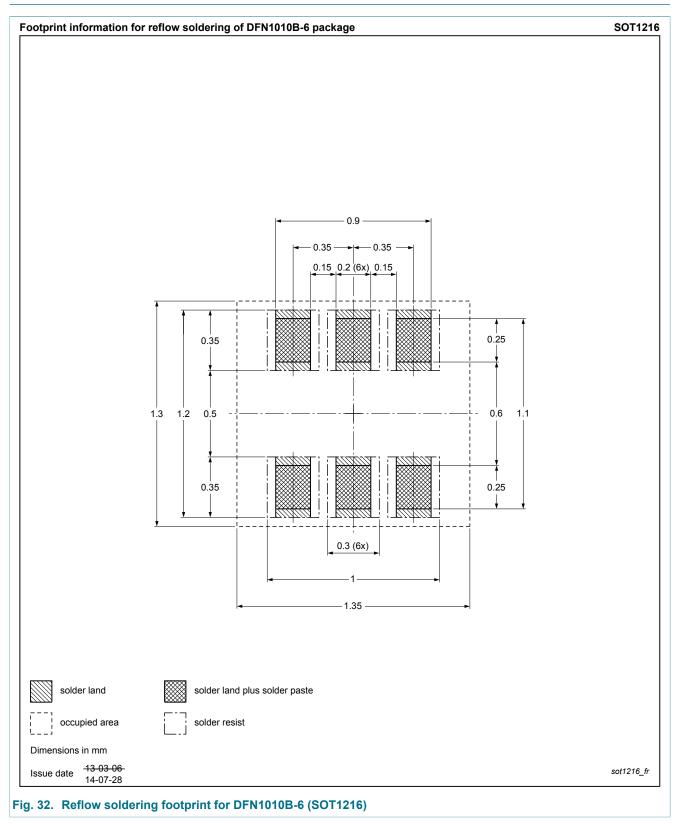
### **10. Test information**



### 11. Package outline



### 12. Soldering



## 13. Revision history

Table 8. Revision hi	story			
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMCXB900UE v.2	20150630	Product data sheet	-	PMCXB900UE v.1
Modification:	Change of binary m	arking code position.		, 
PMCXB900UE v.1	20131007	Product data sheet	-	-

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#### 14. Legal information

#### 14.1 Data sheet status

Document status [1][2]	Product status [ <u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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